

APPROVAL SHEET

MODEL NO.:	SMD0805-020-24V
CUSTOMER:	S
	23910
CUSTOMER'S APP	ROVAL:
	155
AUTHORIZED SIGN	IATURE/STAMP:
DATE	

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Submitted by:ChenApproved by:YC LinDATE:11-Nov-22

SEA & LAND ELECTRONIC CORP.

SMD0805-020-24V

Features

- Surface Mount Devices
- Lead free device
- Size 2.0*1.2 mm / 0.08*0.05 inch
- Surface Mount packaging for automated assembly

Applications

- Almost anywhere there is a low voltage power supply, up to 15V and a load to be protected, including: Computer mother board, Modem. USB hub
- PDAs & Charger, Analog & digital line card

Digital cameras, Disk drivers, CD-ROMs,

Alpha-Top (Sea & Land Alliance)

Performance Specification

Model	Marking	V _{max}	_{nax} I _{max} I _h	I _{hold}	I _{hold} I _{trip}	P _d	Maximum Time To Trip		Resistance		Agency Approval	
Model	Marking	(Vdc)	(A)	@25°C (A)	@25°C (A)	Тур. (W)	Current (A)	Time (Sec)	Ri _{min} (Ω)	R1max (Ω)	UL	TUV
SMD0805-020-24	/ 2	24	100	0.20	0.50	0.5	8.0	0.02	0.650	3.500		
Ihold = Hold Current	nt. Maximum cu	rrent device v	vill not trip in	25°C still ai	r.							
Itrip = Trip Current	. Minimum curre	ent at which t	he device wi	ll always trip	in 25°C still	air.						
Vmax = Maximum o	Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).											
Imax = Maximum f	ault current dev	ice can withs	tand without	damage at	rated voltage	e (Vmax).						
Pd = Power dissi	ation when dev	rice is in the t	ripped state	in 25°C still	air environm	ent at rated	voltage.					
Rimin/max = Minim	Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.											
R1 _{max} = Maximum o	R1 _{max} = Maximum device resistance is measured one hour post reflow.											
CAUTION : Operation	n beyond the sp	pecified rating	gs may resul	t in damage	and possible	e arcing and	flame.	-				

CAUTION : Operation beyond the specified ratings may	y result in damage and possible arcing and flame.
Environmental Specifications	23173910
Test	Conditions
Passive aging	+85°C, 1000 hrs.
Humidity aging	+85°C, 8 <mark>5%</mark> R.H. , 168 hours
Thermal shock	+85°C to -40°C, 20 times
Resistance to solvent	MIL-STD-202, Method 215
Vibration	MIL-STD-202, Method 201
Ambient operating conditions : - 40 °C to +85 °C	
Maximum surface temperature of the device in the tripp	ed state is 125 °C
In case of special use, please contact our engineer	

Agency Approvals :

Regulation/Standard:

PB ROHS

2015/863/EU

EN14582

Ihold Versus Temperature

Model	Maximum ambient operating temperature (T_{mao}) vs. hold current (I_{hold})							I _{hold})	
Model	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
SMD0805-020-24V	0.280	0.250	0.230	0.20	0.170	0.140	0.120	0.100	0.070



SMD0805-020-24V

Alpha-Top (Sea & Land Alliance)

Construction	And	Dimension	(Unit:mm)

Model		4		3	(;	D	E
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
SMD0805-020-24V	1.90	2.20	1.20	1.50	0.50	1.20	0.20	0.10

Dimensions & Marking





Termination Pad Characteristics

Terminal pad materials :

Terminal pad solderability :

Tin-plated Nickel-Copper Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

Rework

Use standard industry practices, the removal device must be replaced with a fresh one. Thermal Derating Curve



Typical Time-To-Trip At 25°C



\Lambda WARNING:

· Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.

• PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated. • Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components. • Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.

Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.

Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.
Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.



SMD0805-020-24V

Alpha-Top (Sea & Land Alliance)



SMD0805	020-24V	Tape & Reel Quantity
Product name	Hold	
Size 2012 mm / 0805 inch	Current	5,000 pcs/reel
SMD: surface mount device	0.20A	

Tape & reel packaging per EIA481-1 Labeling Information

